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[Alpha & Omega Semiconductor Inc.](#)
[AOK75B60D1](#)

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ALPHA & OMEGA
SEMICONDUCTOR

AOK75B60D1

600V, 75A Alpha IGBT™ with Diode

General Description

- AlphaIGBT (αIGBT) technology
- Low $V_{CE(SAT)}$ enables high efficiencies
- Smooth Switching waveforms reduce EMI
- Better thermal management
- Minimal gate spike under high dV/dt

Applications

- Welding Machines
- Solar Inverters
- Uninterruptible Power Supplies

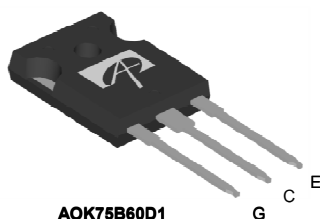
Product Summary

V_{CE}	600V
I_C ($T_C=100^\circ\text{C}$)	75A
$V_{CE(sat)}$ ($T_J=25^\circ\text{C}$)	1.72V

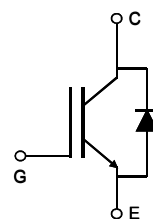


Top View

TO-247



AOK75B60D1



Orderable Part Number		Package Type	Form	Minimum Order Quantity
AOK75B60D1		TO247	Tube	240
Absolute Maximum Ratings $T_A=25^{\circ}\text{C}$ unless otherwise noted				
Parameter		Symbol	AOK75B60D1	Units
Collector-Emitter Voltage		V_{CE}	600	V
Gate-Emitter Voltage		V_{GE}	± 20	V
Continuous Collector Current	$T_C=25^{\circ}\text{C}$	I_C	150	A
	$T_C=100^{\circ}\text{C}$		75	
Pulsed Collector Current, Limited by T_{Jmax}		I_{CM}	290	A
Turn off SOA, $V_{CE} \leq 600\text{V}$, Limited by T_{Jmax}		I_{LM}	290	A
Continuous Diode Forward Current	$T_C=25^{\circ}\text{C}$	I_F	75	A
	$T_C=100^{\circ}\text{C}$		37.5	
Diode Pulsed Current, Limited by T_{Jmax}		I_{FM}	290	A
Short circuit withstanding time $V_{GE} = 15\text{V}$, $V_{CE} \leq 400\text{V}$, Delay between short circuits $\geq 1.0\text{s}$, $T_C=150^{\circ}\text{C}$		t_{SC}	10	μs
Power Dissipation	$T_C=25^{\circ}\text{C}$	P_D	500	W
	$T_C=100^{\circ}\text{C}$		200	
Junction and Storage Temperature Range		T_J, T_{STG}	-55 to 150	$^{\circ}\text{C}$
Maximum lead temperature for soldering purpose, 1/8" from case for 5 seconds		T_L	300	$^{\circ}\text{C}$
Thermal Characteristics				
Parameter		Symbol	AOK75B60D1	Units
Maximum Junction-to-Ambient		$R_{\theta JA}$	40	$^{\circ}\text{C/W}$
Maximum IGBT Junction-to-Case		$R_{\theta JC}$	0.25	$^{\circ}\text{C/W}$
Maximum Diode Junction-to-Case		$R_{\theta JC}$	0.95	$^{\circ}\text{C/W}$



Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
STATIC PARAMETERS						
BV_{CES}	Collector-Emitter Breakdown Voltage	$I_C=1mA, V_{GE}=0V, T_J=25^{\circ}C$	600	-	-	V
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$V_{GE}=15V, I_C=75A$	$T_J=25^{\circ}C$	-	1.72	2.1
			$T_J=125^{\circ}C$	-	2	-
			$T_J=150^{\circ}C$	-	2.1	-
V_F	Diode Forward Voltage	$V_{GE}=0V, I_C=37.5A$	$T_J=25^{\circ}C$	-	1.44	2
			$T_J=125^{\circ}C$	-	1.43	-
			$T_J=150^{\circ}C$	-	1.41	-
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$V_{CE}=5V, I_C=1mA$	-	5.35	-	V
I_{CES}	Zero Gate Voltage Collector Current	$V_{CE}=600V, V_{GE}=0V$	$T_J=25^{\circ}C$	-	-	10
			$T_J=125^{\circ}C$	-	-	1250
			$T_J=150^{\circ}C$	-	-	6250
I_{GES}	Gate-Emitter leakage current	$V_{CE}=0V, V_{GE}=\pm 20V$	-	-	± 100	nA
g_{FS}	Forward Transconductance	$V_{CE}=20V, I_C=75A$	-	36	-	S
DYNAMIC PARAMETERS						
C_{ies}	Input Capacitance	$V_{GE}=0V, V_{CE}=25V, f=1MHz$	-	4750	-	pF
C_{oes}	Output Capacitance		-	470	-	pF
C_{res}	Reverse Transfer Capacitance		-	16	-	pF
Q_g	Total Gate Charge	$V_{GE}=15V, V_{CE}=480V, I_C=75A$	-	118	-	nC
Q_{ge}	Gate to Emitter Charge		-	48	-	nC
Q_{gc}	Gate to Collector Charge		-	36	-	nC
$I_{C(SC)}$	Short circuit collector current, Max. 1000 short circuits, Delay between short circuits $\geq 1.0s$	$V_{GE}=15V, V_{CE}=400V, R_G=25\Omega$	-	290	-	A
R_g	Gate resistance	$V_{GE}=0V, V_{CE}=0V, f=1MHz$	-	1.5	-	Ω
SWITCHING PARAMETERS, (Load Inductive, $T_J=25^{\circ}C$)						
$t_{D(on)}$	Turn-On DelayTime	$T_J=25^{\circ}C$ $V_{GE}=15V, V_{CE}=400V, I_C=75A,$ $R_G=4\Omega,$ Parasitic Inductance=150nH	-	33	-	ns
t_r	Turn-On Rise Time		-	69	-	ns
$t_{D(off)}$	Turn-Off Delay Time		-	84	-	ns
t_f	Turn-Off Fall Time		-	18.4	-	ns
E_{on}	Turn-On Energy		-	3.7	-	mJ
E_{off}	Turn-Off Energy		-	1.3	-	mJ
E_{total}	Total Switching Energy		-	5	-	mJ
t_{rr}	Diode Reverse Recovery Time	$T_J=25^{\circ}C$ $I_F=37.5A, di/dt=200A/\mu s, V_{CE}=400V$	-	147	-	ns
Q_{rr}	Diode Reverse Recovery Charge		-	0.9	-	μC
I_{rm}	Diode Peak Reverse Recovery Current		-	10	-	A
SWITCHING PARAMETERS, (Load Inductive, $T_J=150^{\circ}C$)						
$t_{D(on)}$	Turn-On DelayTime	$T_J=150^{\circ}C$ $V_{GE}=15V, V_{CE}=400V, I_C=75A,$ $R_G=4\Omega,$ Parasitic Inductance=150nH	-	30	-	ns
t_r	Turn-On Rise Time		-	75	-	ns
$t_{D(off)}$	Turn-Off Delay Time		-	105	-	ns
t_f	Turn-Off Fall Time		-	16	-	ns
E_{on}	Turn-On Energy		-	4.2	-	mJ
E_{off}	Turn-Off Energy		-	1.9	-	mJ
E_{total}	Total Switching Energy		-	6.1	-	mJ
t_{rr}	Diode Reverse Recovery Time	$T_J=150^{\circ}C$ $I_F=37.5A, di/dt=200A/\mu s, V_{CE}=400V$	-	235	-	ns
Q_{rr}	Diode Reverse Recovery Charge		-	1.9	-	μC
I_{rm}	Diode Peak Reverse Recovery Current		-	15	-	A

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

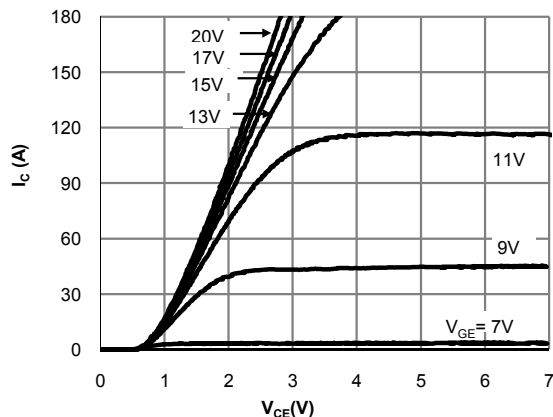


Fig 1: Output Characteristic
($T_J = 25^\circ\text{C}$)

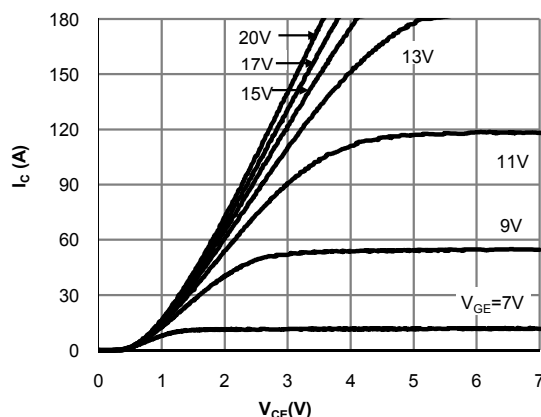


Fig 2: Output Characteristic
($T_J = 150^\circ\text{C}$)

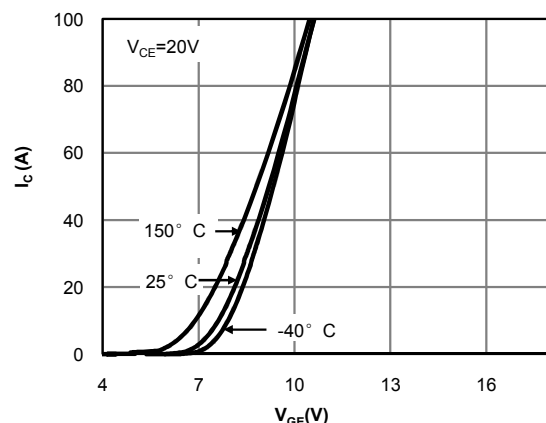


Fig 3: Transfer Characteristic

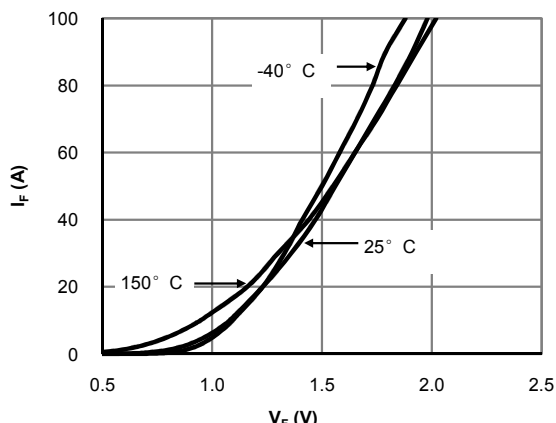


Fig 4: Diode Characteristic

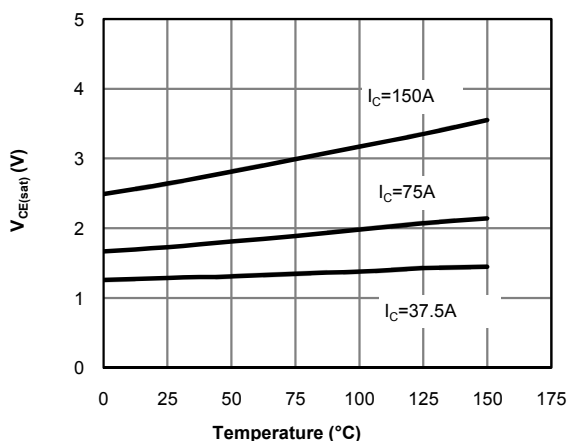


Fig 5: Collector-Emitter Saturation Voltage vs.
Junction Temperature

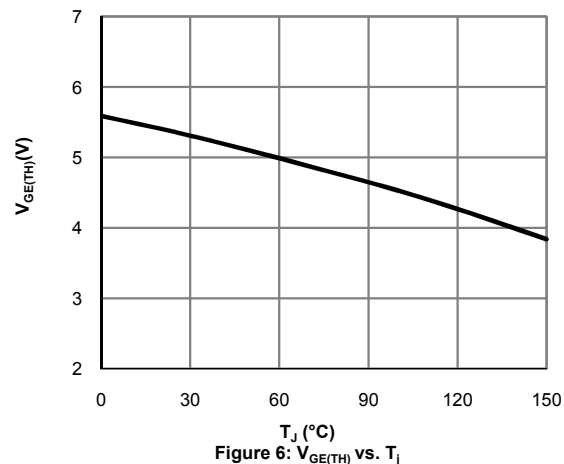
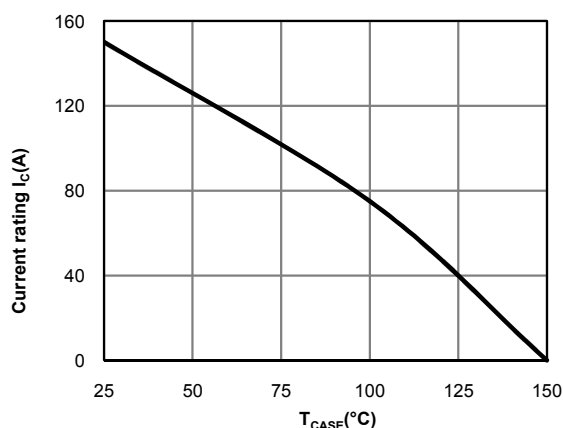
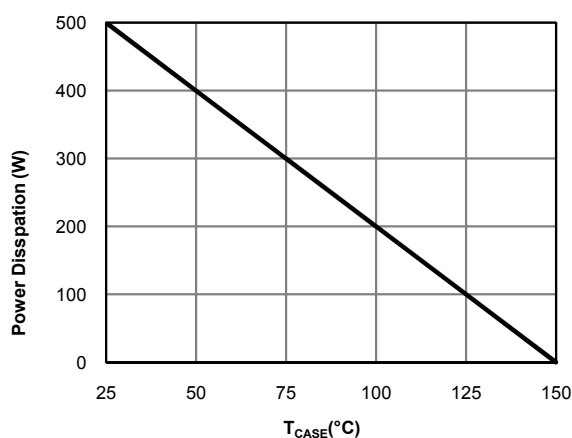
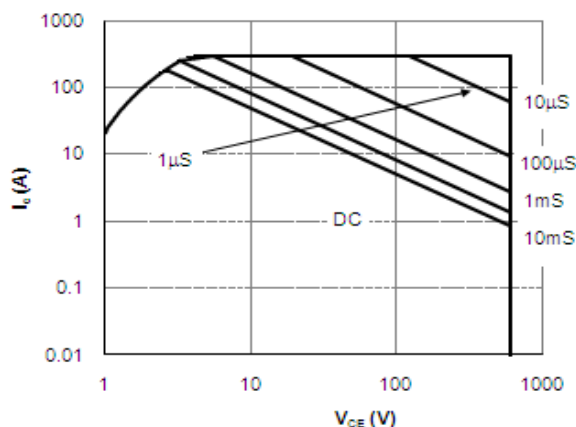
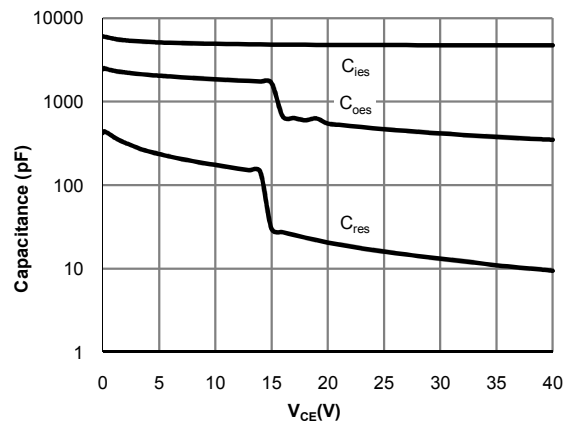
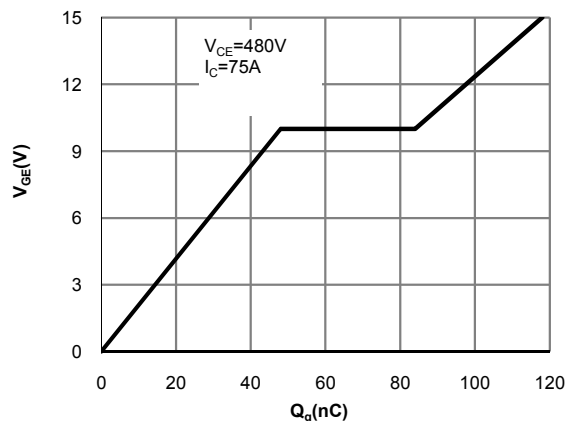


Figure 6: $V_{GE(TH)}$ vs. T_J

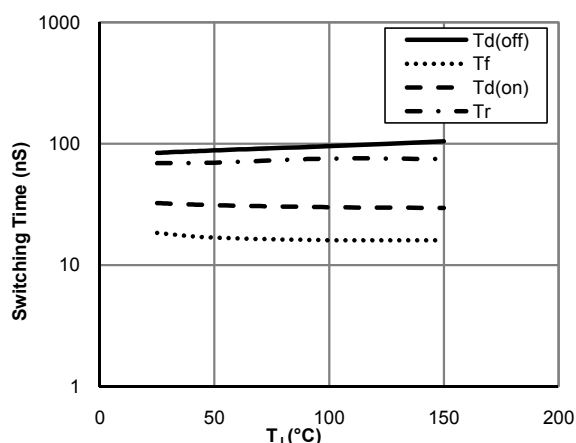
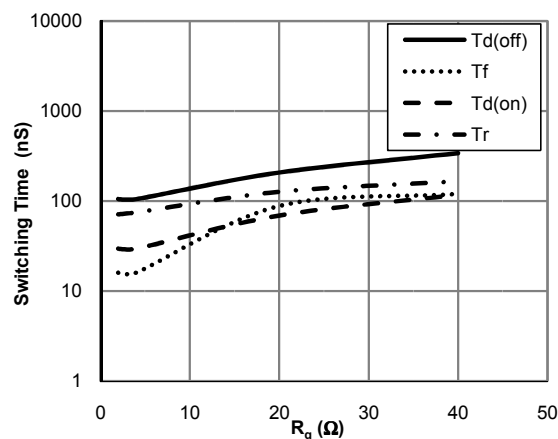
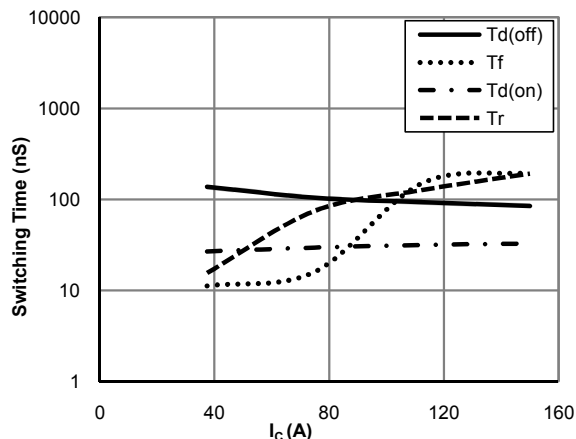


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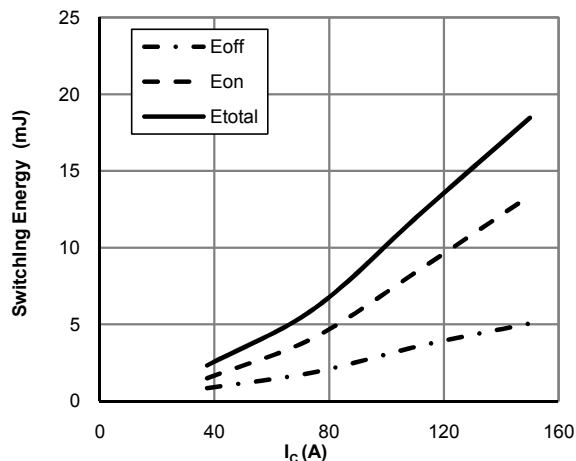


Figure 15: Switching Loss vs. I_C
($T_J=150^\circ\text{C}$, $V_{GE}=15\text{V}$, $V_{CE}=400\text{V}$, $R_g=4\Omega$)

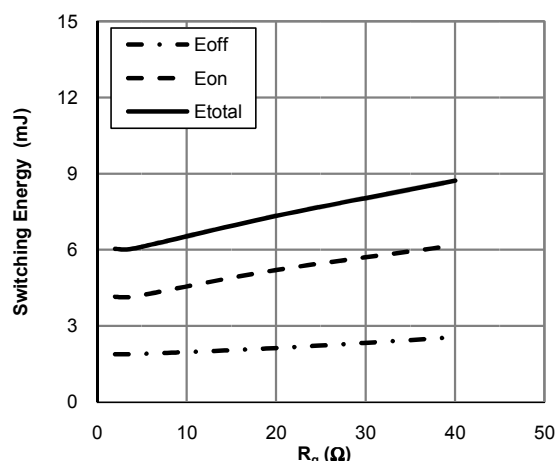


Figure 16: Switching Loss vs. R_g
($T_J=150^\circ\text{C}$, $V_{GE}=15\text{V}$, $V_{CE}=400\text{V}$, $I_C=75\text{A}$)

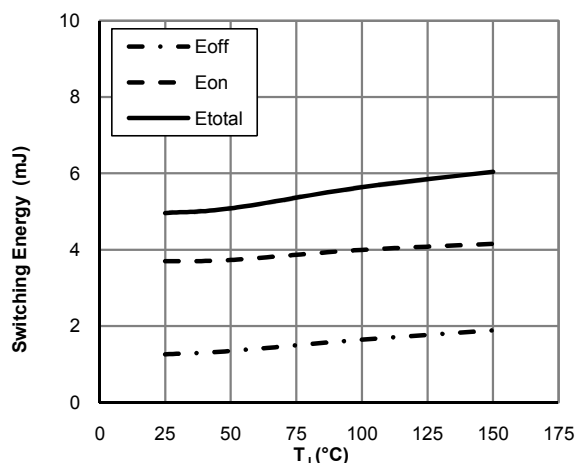


Figure 17: Switching Loss vs. T_J
($V_{GE}=15\text{V}$, $V_{CE}=400\text{V}$, $I_C=75\text{A}$, $R_g=4\Omega$)

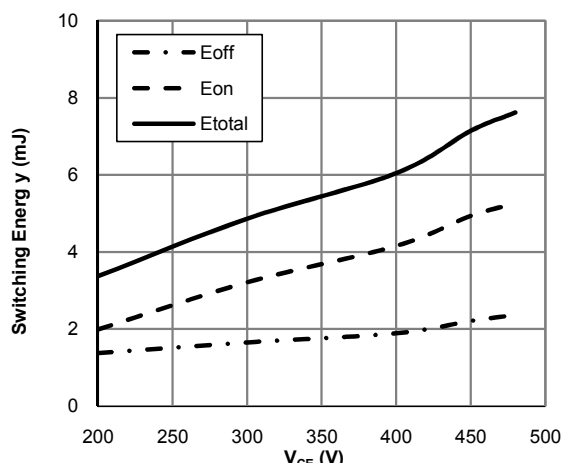


Figure 18: Switching Loss vs. V_{CE}
($T_J=150^\circ\text{C}$, $V_{GE}=15\text{V}$, $I_C=75\text{A}$, $R_g=4\Omega$)



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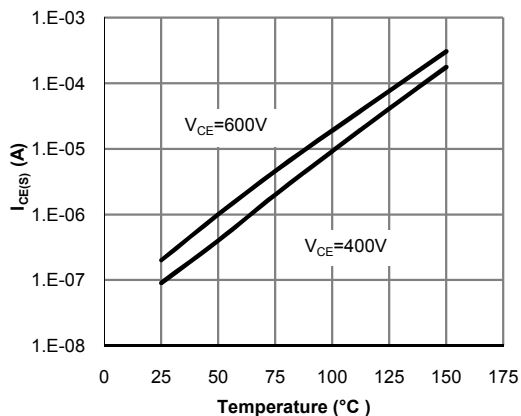


Fig 19: Diode Reverse Leakage Current vs. Junction Temperature

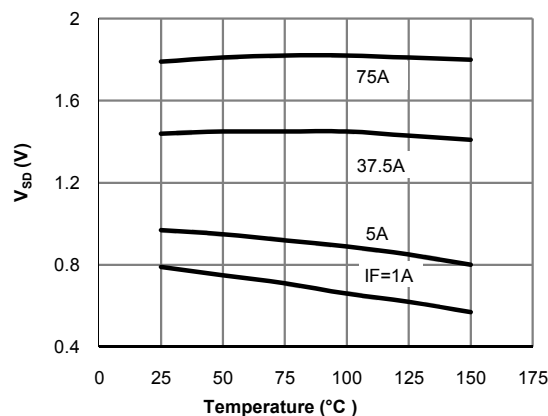


Fig 20: Diode Forward voltage vs. Junction Temperature

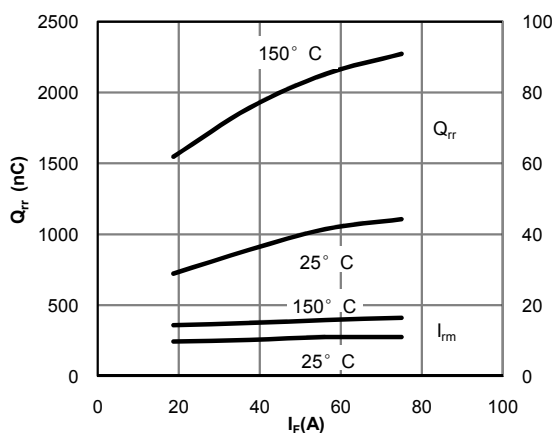


Fig 21: Diode Reverse Recovery Charge and Peak Current vs. Conduction Current ($V_{GE}=15\text{V}$, $V_{CE}=400\text{V}$, $di/dt=200\text{A}/\mu\text{s}$)

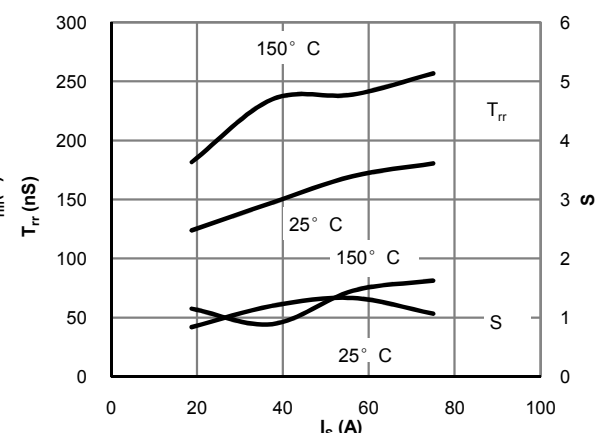


Fig 22: Diode Reverse Recovery Time and Softness Factor vs. Conduction Current ($V_{GE}=15\text{V}$, $V_{CE}=400\text{V}$, $di/dt=200\text{A}/\mu\text{s}$)

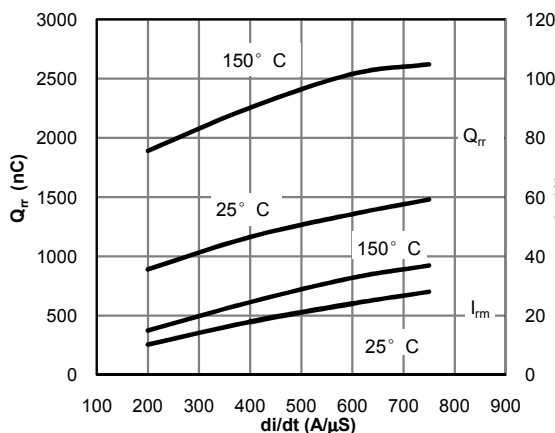


Fig 23: Diode Reverse Recovery Charge and Peak Current vs. di/dt ($V_{GE}=15\text{V}$, $V_{CE}=400\text{V}$, $I_F=37.5\text{A}$)

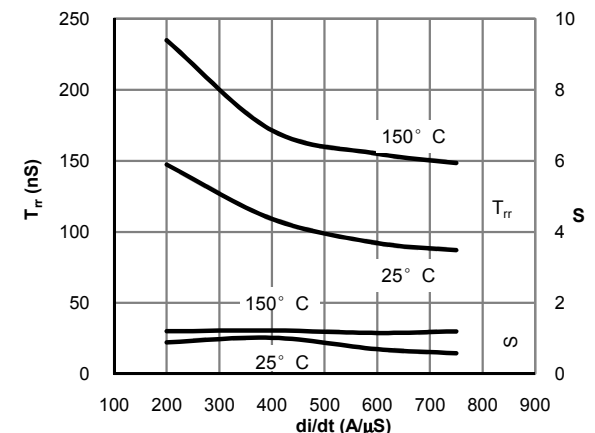


Fig 24: Diode Reverse Recovery Time and Softness Factor vs. di/dt ($V_{GE}=15\text{V}$, $V_{CE}=400\text{V}$, $I_F=37.5\text{A}$)



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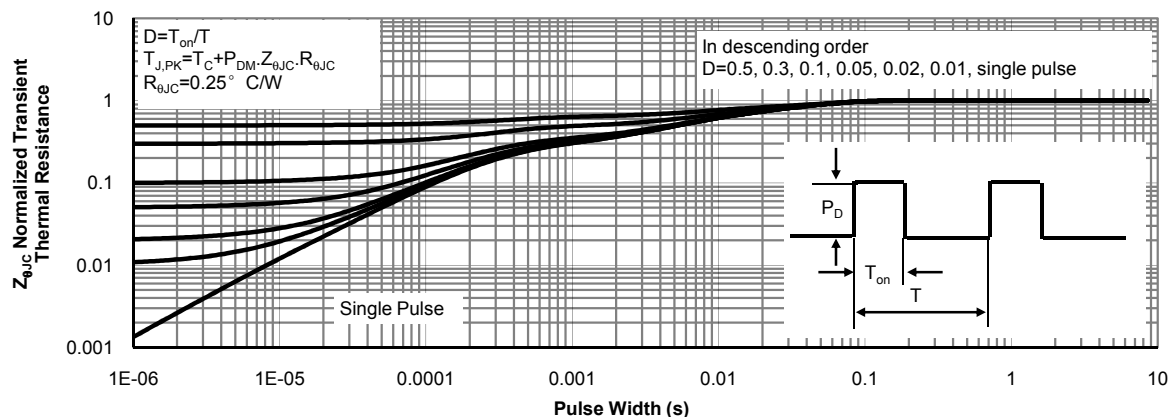


Figure 25: Normalized Maximum Transient Thermal Impedance for IGBT

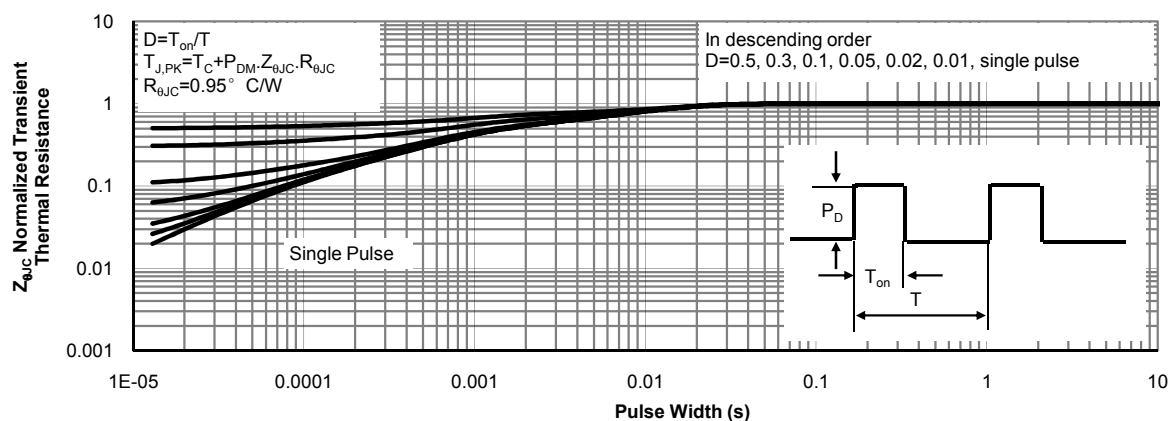
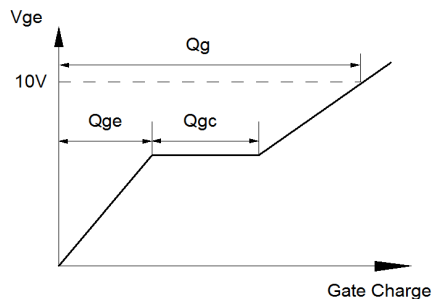
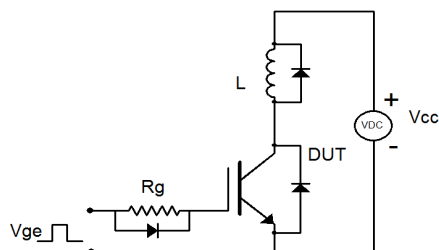


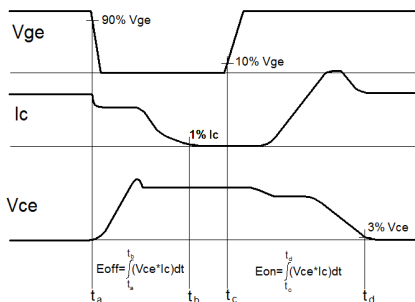
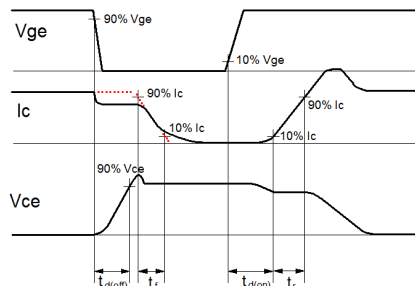
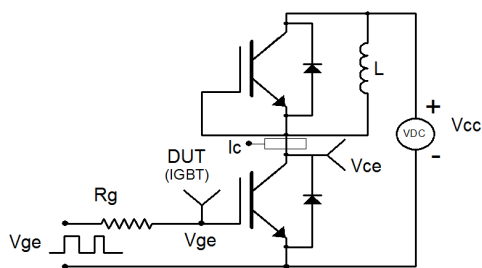
Figure 26: Normalized Maximum Transient Thermal Impedance for Diode



Gate Charge Test Circuit & Waveform



Inductive Switching Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms

